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| INFORMATION DISCLOSURE STATEMENT | Atty. Docket No.: 150.00840102 | Serial No.: 10/770,797 |
| | Applicant(s): Yates et al. | Confirmation No.: Unassigned |
| | Application Filing Date: February 3, 2004 | Group: Unassigned |
| | Information Disclosure Statement mailed: April <u>26</u> , 2004 | |

U.S. PATENT DOCUMENTS

| Examiner Initial | Copy Enclosed | Document Number | Date | Name | Class | Subclass | Filing Date If Appropriate |
|---------------------|------------------|-----------------|----------|----------------|-------|----------|-------------------------------|
| <i>m</i> | | 3,968,565 | 07/13/76 | Bertens et al. | | | |
| | | 5,545,289 | 08/13/96 | Chen et al. | | | |
| | | 5,741,368 | 04/21/98 | Sahbari | | | |
| | | 5,780,359 | 07/14/98 | Brown et al. | | | |
| | | 5,811,022 | 09/22/98 | Savas et al. | | | |
| | | 5,851,302 | 12/22/98 | Solis | | | |
| | | 5,876,903 | 03/02/99 | Ng et al. | | | |
| | | 5,891,803 | 04/06/99 | Gardner | | | |
| | | 6,063,712 | 05/16/00 | Gilton et al. | | | |
| | | 6,162,738 | 12/19/00 | Chen et al. | | | |
| <i>b</i> | | 6,703,319 | 03/09/04 | Yates et al. | | | |

FOREIGN PATENT DOCUMENTS

| Examiner Initial | Copy Enclosed | Document Number | Date | Country | Class | Subclass | Translation | |
|---------------------|------------------|-----------------|----------|---------|-------|----------|-------------|----|
| | | | | | | | Yes | No |
| <i>m</i> | | 0662705 A2 | 12/29/94 | Europe | | | | |
| | | 0773480 A1 | 11/13/96 | Europe | | | | |
| | | 411067703 | 03/9/99 | Japan | | | | |
| <i>b</i> | | WO 99/45443 | 09/10/99 | PCT | | | | |

OTHER DOCUMENTS (Including Authors, Title, Date, Pertinent Papers, etc.)

| Examiner Initial | Copy Enclosed | Document Description |
|---------------------|------------------|---|
| <i>m</i> | | "Material Safety Data Sheet for PRX-407 [®] ", Silicon Valley Chemlabs, Inc., Sunnyvale, VA 94086, 1998:4 pgs. |

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| EXAMINER <i>[Signature]</i> | Date Considered <i>5/24/07</i> |
| *Examiner: Initial if citation considered, whether or not citation is in conformance with MPEP 609: Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. | |

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| | Applicant(s): Yates et al. | Confirmation N .: Unassigned |
| | Application Filing Date: February 3, 2004 | Group: Unassigned |
| | Information Disclosure Statement mailed: April 26, 2004 | |

| Examiner Initial | Copy Enclosed | Document Description |
|------------------|---------------|---|
| | | "Material Safety Data Sheet", Shipley, <i>PRX-407 Advanced Plasma Etch Polymer Remover</i> , July 26, 2000:7 pgs. |
| | | Product information for: PRX-407 [®] Advanced Plasma Etch Polymer Remover, Silicon Valley Chemlabs, Inc., Sunnyvale, CA 94086, 1998 |
| | | "Post-Etch SWP Removal," SVC Silicon Valley Chemlabs, Inc., Sunnyvale, CA 94086:5 pgs. |
| | | "Product Selection Guide," SVC Silicon Valley Chemlabs, Inc., Sunnyvale, CA 94086:2 pgs |
| | | Sotoaka et al., "Cleaning solvent for manufacturing semiconductor element and semiconductor element using the same," English Abstract of JP 411067703 A:1 pg. |
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| EXAMINER | Date Considered |
| <small>* Examiner: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.</small> | |

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Page 1 of 1

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| INFORMATION DISCLOSURE STATEMENT | Atty. Docket No.: 150.00840102 | Serial No.: 10/770,797 |
| | Applicant(s): Yates et al. | Confirmation No.: 1476 |
| | Application Filing Date: February 3, 2004 | Group: 1751 |
| | Information Disclosure Statement mailed: February 28, 2007 | |

U.S. PATENT DOCUMENTS


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|------------------|---------------|-----------------|------|------|-------|----------|----------------------------|
| | | None | | | | | |
| | | | | | | | |

FOREIGN PATENT DOCUMENTS

| Examiner Initial | Copy Enclosed | Document Number | Date | Country | Class | Subclass | Translation | |
|------------------|---------------|-----------------|-------------------|---------|-------|----------|-------------|----|
| | | | | | | | Yes | No |
| M | X | WO 98/40338 | 17 September 1998 | PCT | | | | |
| | | | | | | | | |

OTHER DOCUMENTS (Including Authors, Title, Date, Pertinent Papers, etc.)

| Examiner Initial | Copy Enclosed | Document Description |
|------------------|---------------|----------------------|
| | | None |
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|--|-----------------------------------|
| EXAMINER  | Date Considered 5/24/07 |
| *Examiner: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. | |